

**TS836**

MICROPOWER VOLTAGE SUPERVISOR RESET ACTIVE HIGH

- ULTRA LOW POWER CONSUMPTION: 12 μ A max. at V_{cc} = 5V
- PRECISION RESET THRESHOLD (guaranteed over Temperature)
- THRESHOLD VOLTAGE:
4.50V typ. FOR TS836-4
- GUARANTEED RESET OPERATION FOR V_{cc} DOWN TO 1V
- OPEN DRAIN OUTPUT COMPARATOR WITH V_{ol} = 450mV typ. @ I_{ol} = 8mA & V_{cc} = 4V
- FAST RESPONSE TIME: 20 μ s FOR A 10mV OVERDRIVE
- 100mV INTERNAL HYSTERESIS

DESCRIPTION

The TS836 ultra low power integrated circuit incorporates a high stability band-gap voltage reference and a comparator with open drain output.

The threshold voltage is set at 4.5V for TS836-4 by internal thermally matched resistances.

The comparator exhibits a 20 μ s response (with 10mV overdrive) and has an open drain output active when input voltage is lower than the threshold.

An internal hysteresis of 100mV increases the comparator's noise margin and prevents false reset operation.

APPLICATION

- Power-on reset generator for micro controller
- Power failure detector

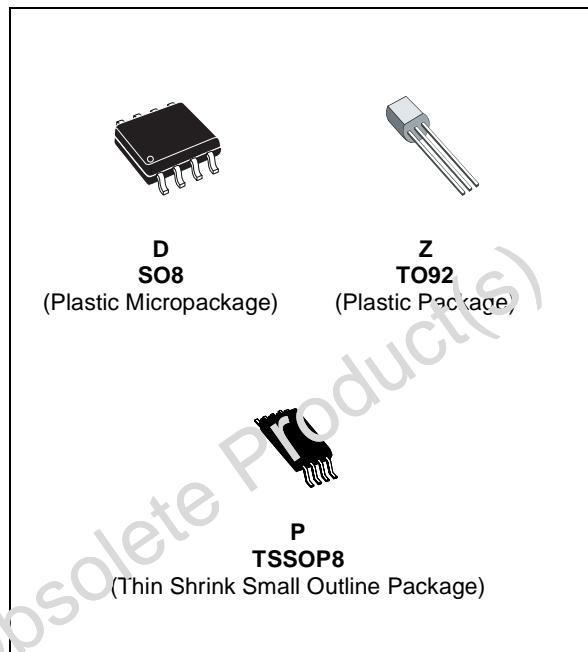
ORDER CODE

Part Number	Temperature Range	Package		
		D	Z	P
TS836-4I	-40, +85°C	•	•	•

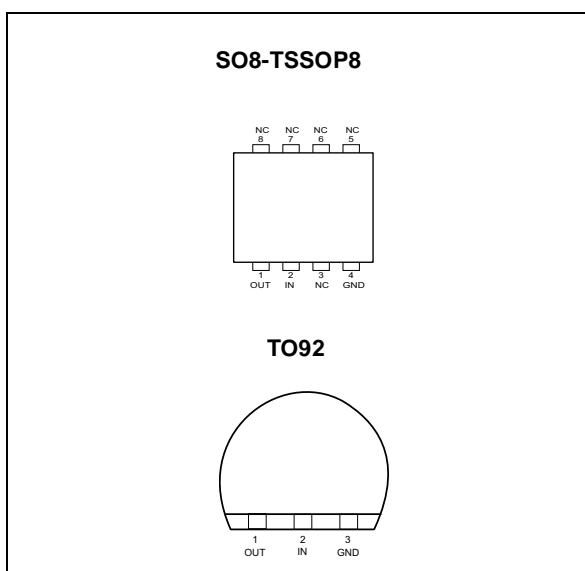
Z= TO92 Plastic package - also available in Bulk (Z), Tape & Reel (ZT) and Ammo Pack (AP)

D = Small Outline Package (SO) - also available in Tape & Reel (DT)

P = Thin Shrink Small Outline Package (TSSOP) - only available in Tape & Reel (PT)



PIN CONNECTIONS (top view)



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage ¹⁾	7	V
V_{OUT}	Output Voltage	-0.3 to $V_{CC} + 0.3$	V
I_{OUT}	Output Current	20	mA
P_D	Power Dissipation ²⁾ SO8 TSSOP8 TO92	700 625 625	mW
T_{STG}	Storage Temperature	-65 to +150	°C

1. All voltages values, except differential voltage are with respect to network ground terminal.

2. P_D is calculated with $T_{AMB}=+25^\circ\text{C}$, $T_J=+150^\circ\text{C}$ and
 $R_{THJA}=175^\circ\text{C}/\text{W}$ for SO8 package
 $R_{THJA}=200^\circ\text{C}/\text{W}$ for TSSOP8 package
 $R_{THJA}=200^\circ\text{C}/\text{W}$ for TO92 package

OPERATING CONDITIONS

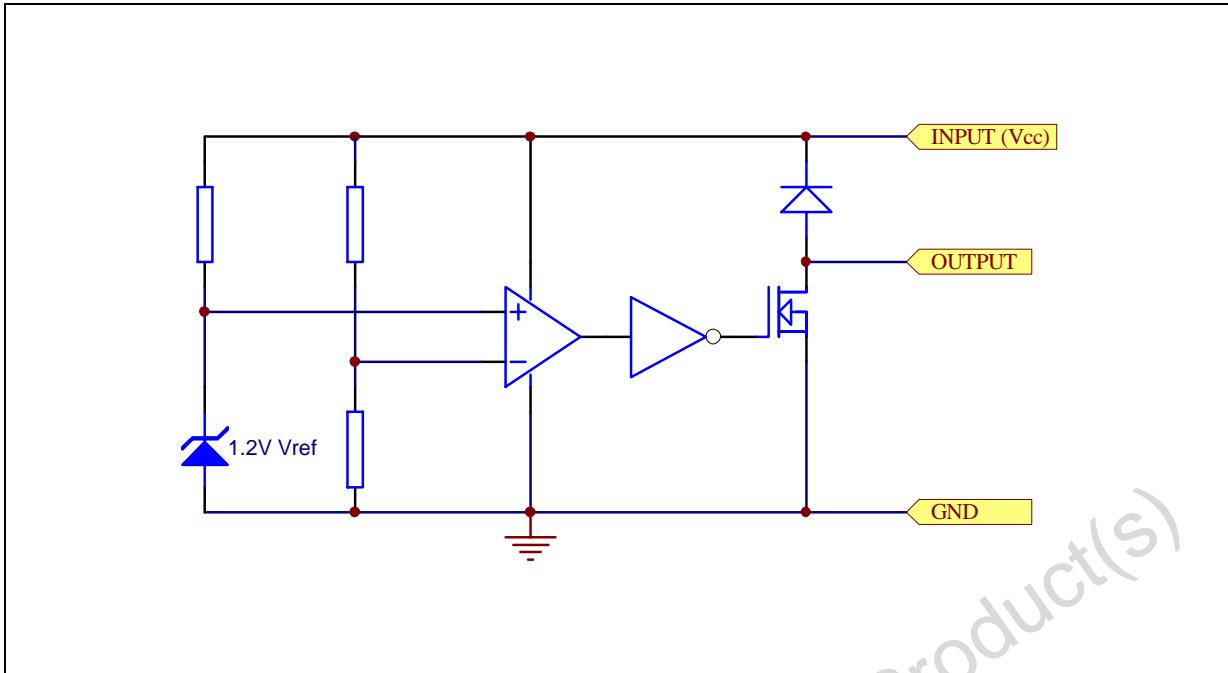
Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	1 to 5.5	V
T_{OPER}	Operating Free Air Temperature Range	-40 to +85	°C

TS836-4

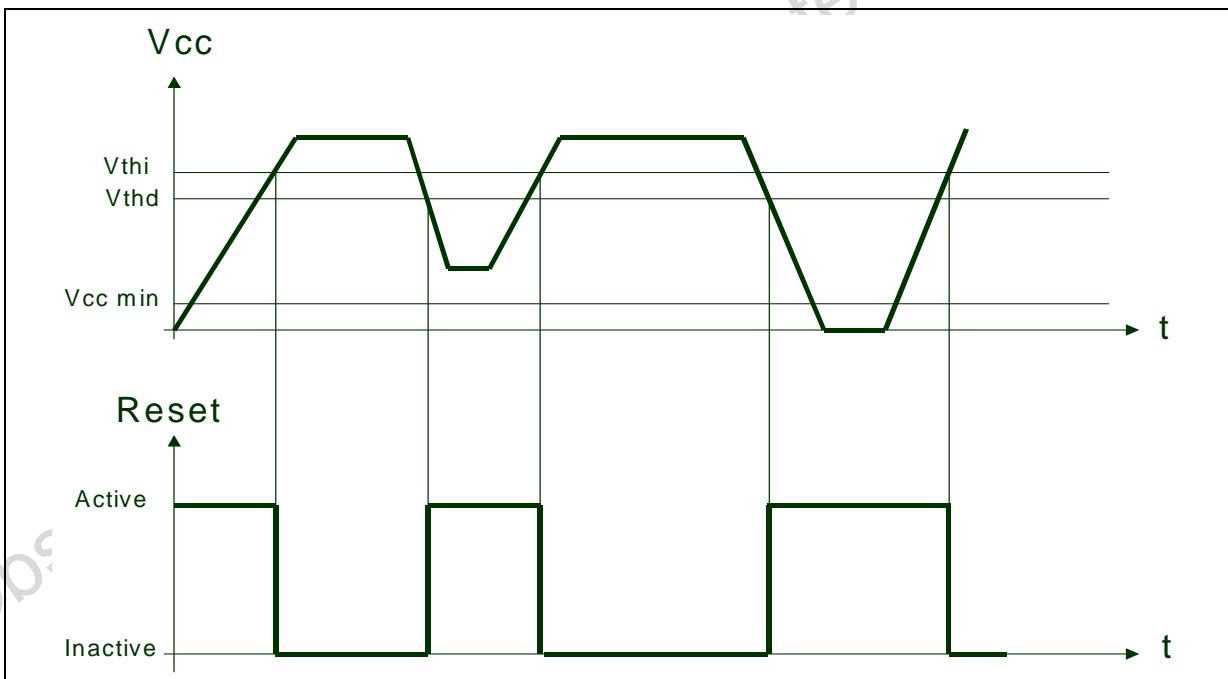
ELECTRICAL CHARACTERISTICS $T_{amb} = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{THI}	Threshold Voltage - V_{CC} Increasing $T_{min.} \leq T_{amb} \leq T_{max.}$	4.17	4.5	4.66	V
V_{THD}	Threshold Voltage - V_{CC} Decreasing $T_{min.} \leq T_{amb} \leq T_{max.}$	4.17	4.4	4.66	V
V_{HYS}	Hysteresis Voltage	50	100	200	mV
I_{CC}	Current Consumption $V_{CC} = 5\text{V}$			12	µA
V_{OL}	Low Level Output Voltage $I_{OL} = 8\text{mA}$, $T_{min.} \leq T_{amb} \leq T_{max.}$	$V_{CC} = 4\text{V}$		450 800 1000	mV
I_{OH}	Output Off-state Leakage $T_{min.} \leq T_{amb} \leq T_{max.}$	$V_{CC} = 5\text{V}$		2 100 1000	nA
T_{PHL}	Response Time High to Low $R_L = 10\text{k}\Omega$, $C_L = 15\text{pF}$, $V_{CC} = V_{thd} - 10\text{mV}$		20		µs

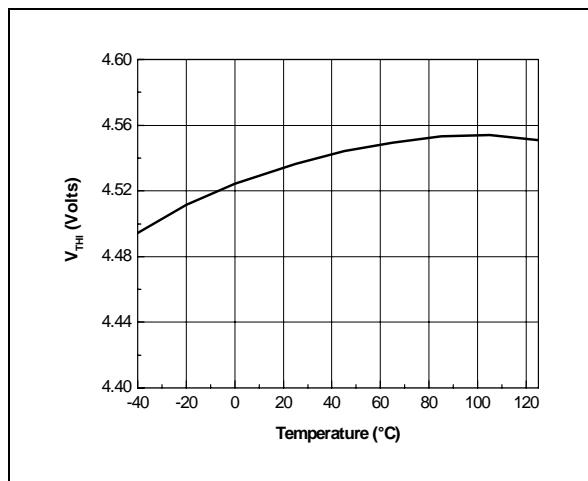
EQUIVALENT SCHEMATIC DIAGRAM



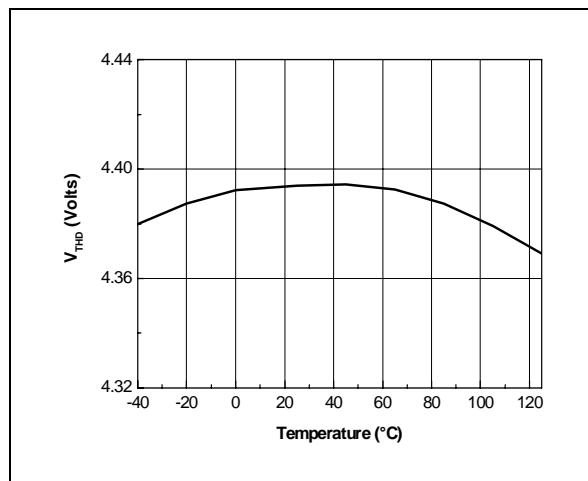
TIMING DIAGRAM



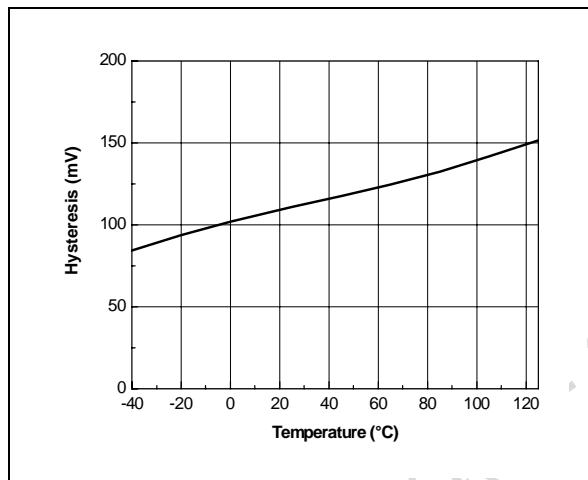
V_{th} vs Temperature while V_{CC} increasing



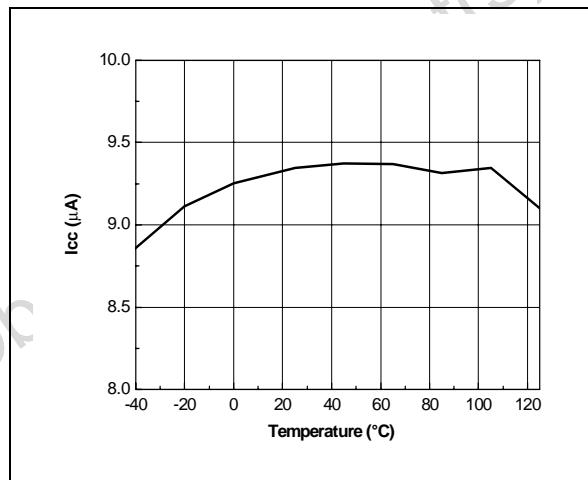
V_{th} vs Temperature while V_{CC} decreasing



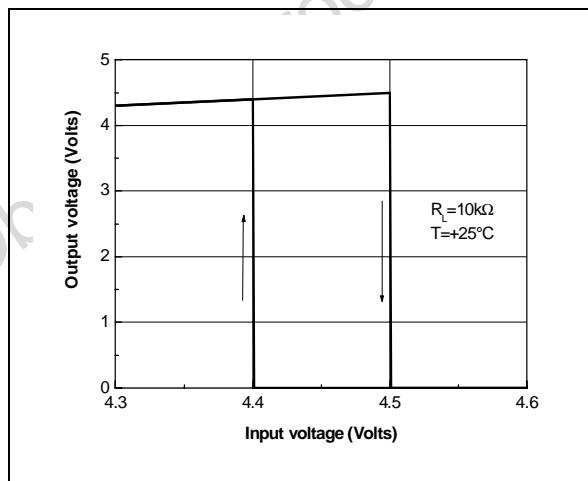
Hysteresis vs Temperature



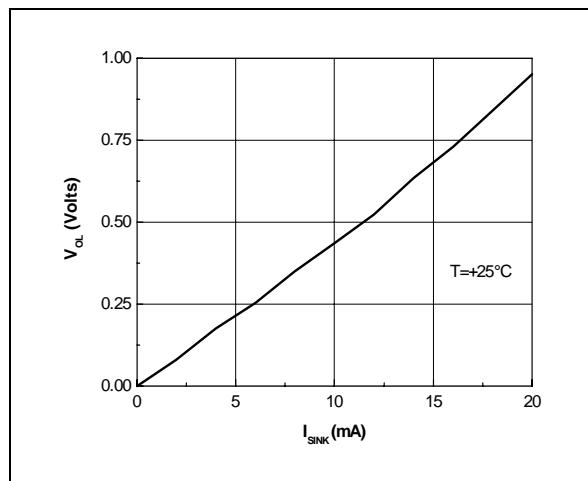
I_{CC} vs Temperature



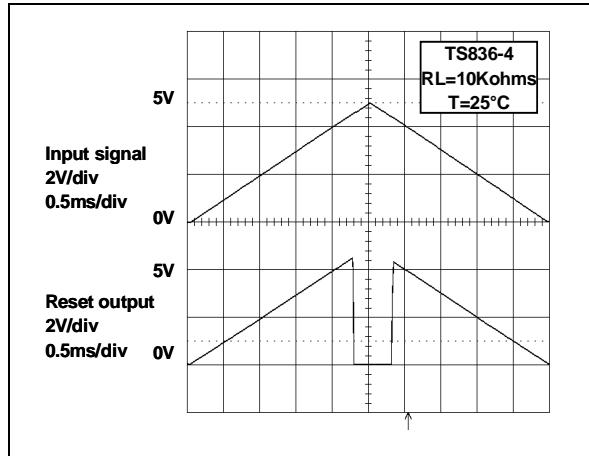
Reset Output Voltage vs Input Voltage



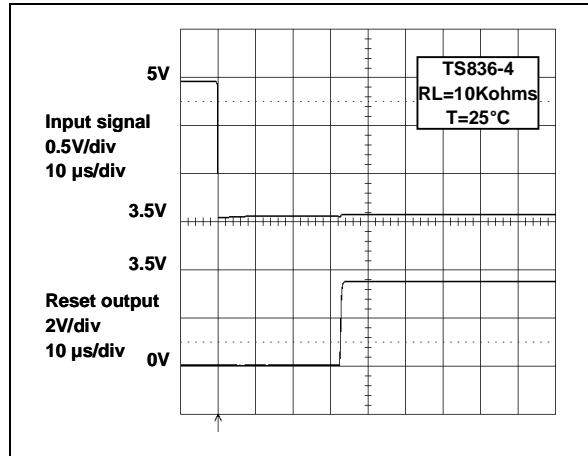
Voltage Output Low vs Sink Current



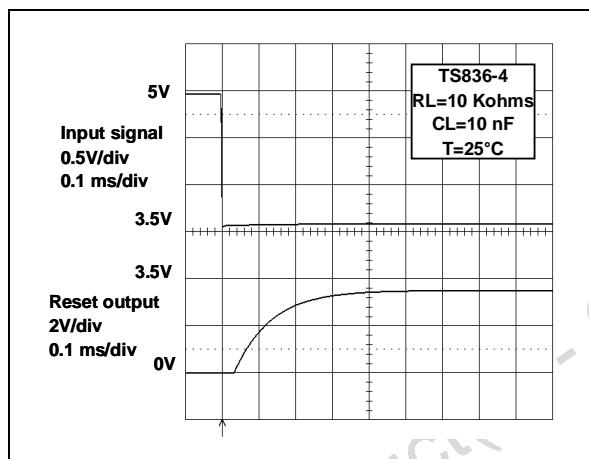
Reset Output Voltage vs Input Voltage



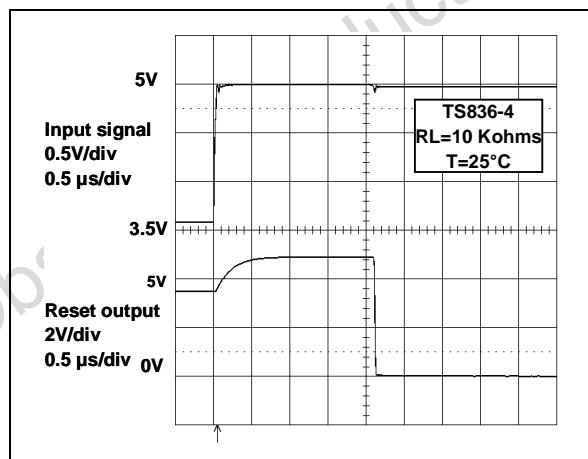
Supply Failing down: Reset Delay Time



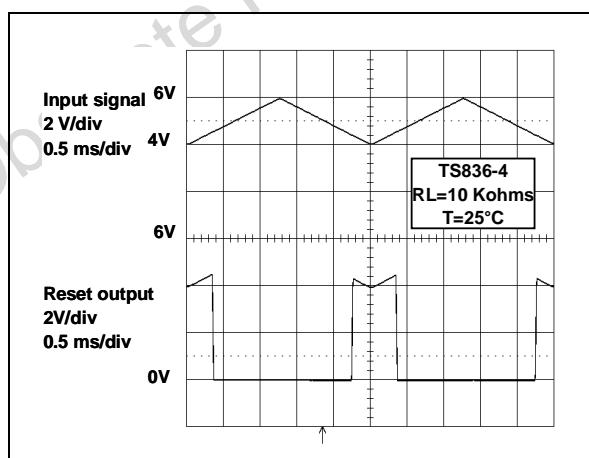
Supply Failing Down: Extended Reset Delay Time with an Additional Capacitor



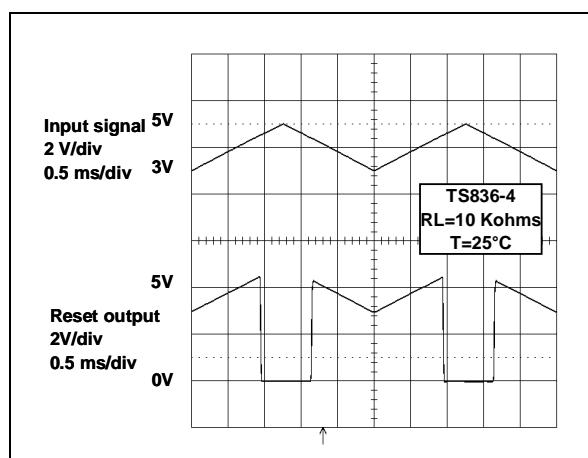
Supply Rising up: Output Delay Time



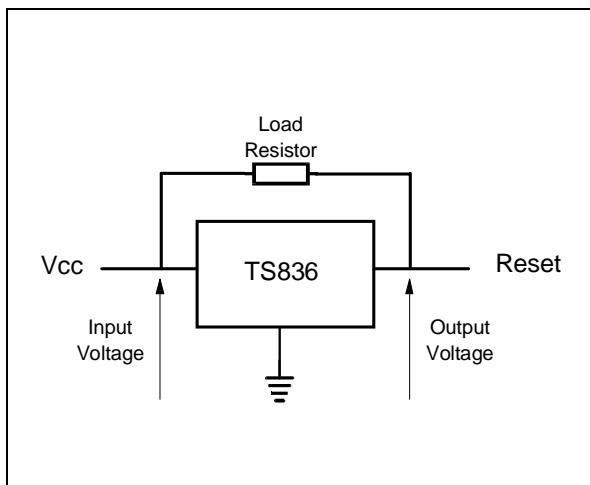
Reset Output Voltage vs Input Voltage (example)



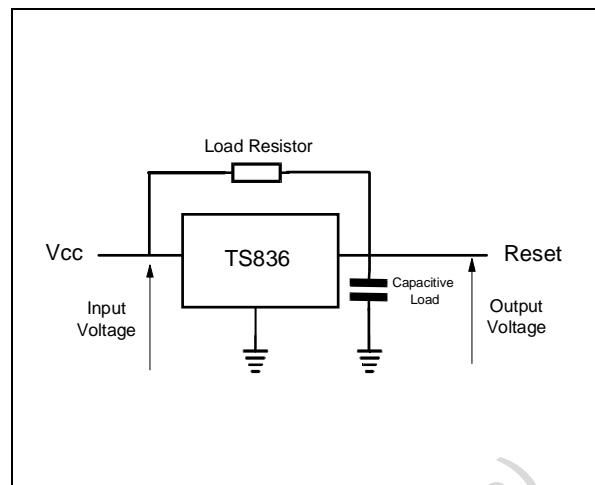
Reset Output Voltage vs Input Voltage (example)



Basic configuration



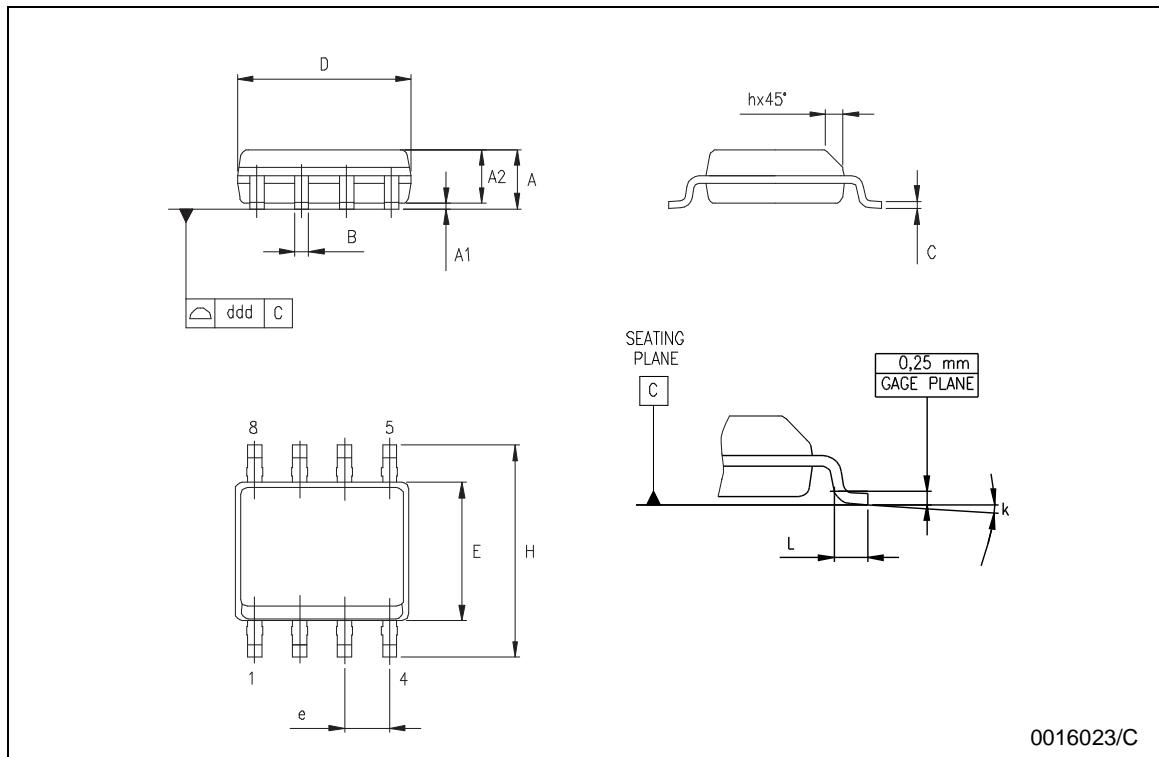
Configuration with an additional Capacitive Load



PACKAGE MECHANICAL DATA

SO-8 MECHANICAL DATA

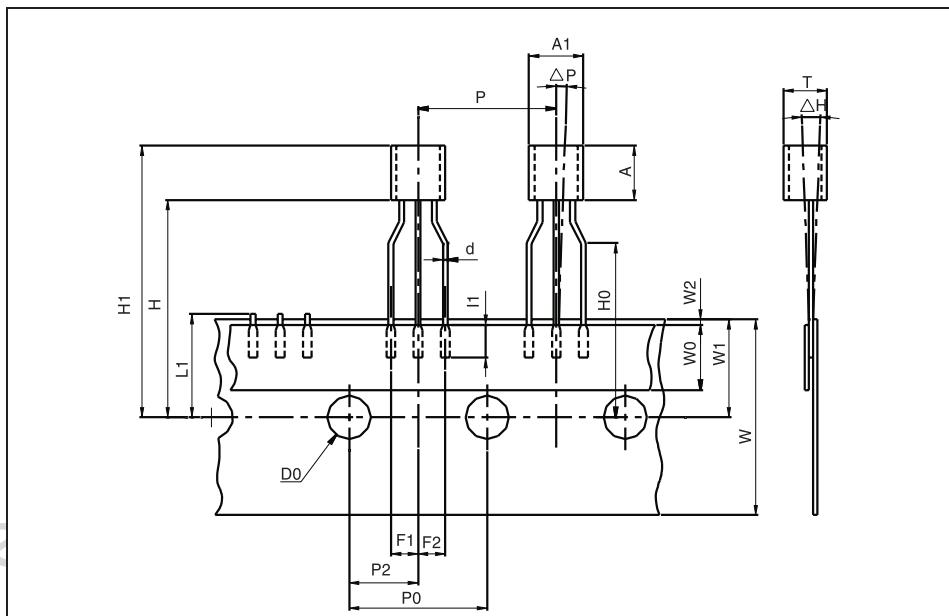
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



PACKAGE MECHANICAL DATA - TO92 TAPE AMMO PACK & TO92 TAPE & REEL

TO-92 MECHANICAL DATA

DIM.	mm.			inches		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
AL			5.0			0.197
A			5.0			0.197
T			4.0			0.157
d	0.45				0.018	
I1	2.5			0.098		
P	11.7	12.7	13.7	0.461	0.500	0.539
PO	12.4	12.7	13	0.488	0.500	0.512
P2	5.95	6.35	6.75	0.234	0.250	0.266
F1/F2	2.4	2.5	2.8	0.094	0.098	0.110
h	-1	0	1	-0.039	0	0.039
P	-1	0	1	-0.039	0	0.039
W	17.5	18.0	19.0	0.689	0.709	0.748
W0	5.7	6	6.3	0.224	0.236	0.248
W1	8.5	9	9.75	0.335	0.354	0.384
W2			0.5			0.020
H			20			0.787
H0	15.5	16	16.5	0.610	0.630	0.650
H1			25			0.984
DO	3.8	4.0	4.2	0.150	0.157	0.165
L1			11			0.433



Packing information are available at: <http://www.st.com/stoneline/prodpres/packages/stdlin.htm>

PACKAGE MECHANICAL DATA - TO92 BULK

TO-92 MECHANICAL DATA						
DIM.	mm.			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.32		4.95	170.1		194.9
b	0.36		0.51	14.2		20.1
D	4.45		4.95	175.2		194.9
E	3.30		3.94	129.9		155.1
e	2.41		2.67	94.9		105.1
e1	1.14		1.40	44.9		55.1
L	12.7		15.49	500.0		609.8
R	2.16		2.41	85.0		94.9
S1	0.92		1.52	36.2		59.8
W	0.41		0.56	16.1		22.0

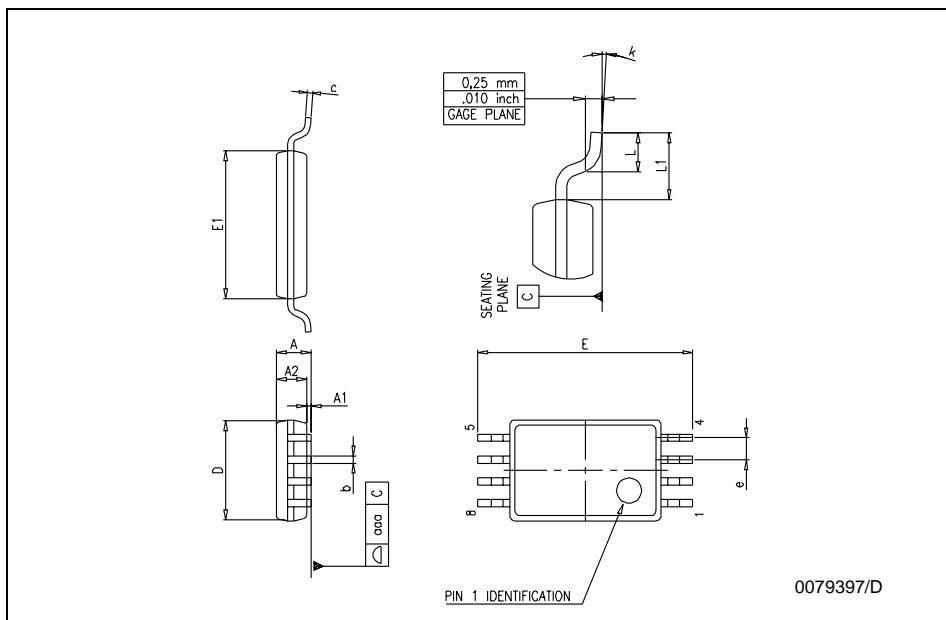
The diagram illustrates the physical dimensions of a TO-92 bulk package. The top view shows the lead spacing (R), lead height (V), and lead thickness (E). The side view shows the total height (L), lead width (W), lead thickness (e1), and the distance from the lead tip to the chip (A). The chip thickness is labeled as S1. Reference dimensions D and b are also indicated.

0102782/C

Packing information are available at: <http://www.st.com/stoneline/prodpres/packages/stdlin.htm>

PACKAGE MECHANICAL DATA

TSSOP8 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	



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